

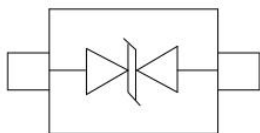
Features

- 23W Peak Pulse Power Per Line(8/20us)
- 5V Working Peak Reverse Voltage
- Maximum Reverse Peak Pulse Current:2A
- ESD per IEC 61000-4-2(Contact):8KV
- ESD per IEC 61000-4-2(Air):15KV
- Clamping Voltage @IPP=1A:9.4V
- Junction Capacitance:1PF
- Package:SOD-523(0603)
- Polarity: Bidirectional

Mechanical Characteristics

- Mechanical Characteristics
- Lead Finish: NiPdAu
- Case Material: “ Green ” Molding Compound.
- UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 3 per J-STD-020
- Terminal Connections: See Diagram Below
- Marking Information: See Below

Schematic And Configuration



Ordering Information

Part Number	Packaging	Reel Size
TEVC1R0V05B1X	Tape & Reel	7inch

Absolute Maximum Ratings (Ta=25°C, RH=45%-75%, unless otherwise noted)

Parameter	Symbol	Value	Unit
Operating Temperature Range	Tj	-55~+150	
Storage Temperature Range	Tstg	-55~+150	

Electrical Characteristics (Ta=25°C)

Parameter	Symbol	Min	Type	Max	Unit	Test Condition
Reverse Working Voltage	Vrwm			5	V	
Breakdown Voltage	Vbr	6.7			V	It=1mA
Reverse Leakage Current	Ir			0.1	uA	Vrwm=5V
Clamping Voltage	Vc		9.4	10	V	Ipp=1A(8 × 20us pulse)
Juntion Capacitance	Cj		1	2	pF	Vr=0V,f=1MHz

Typical Performance Characteristics (Ta=25 , unless otherwise noted)

Figure 1: Peak Pulse Power Vs Pulse Time

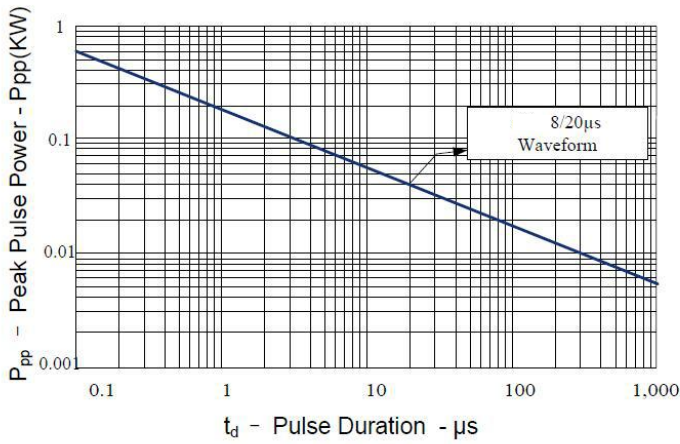


Figure 2: Power Derating Curve

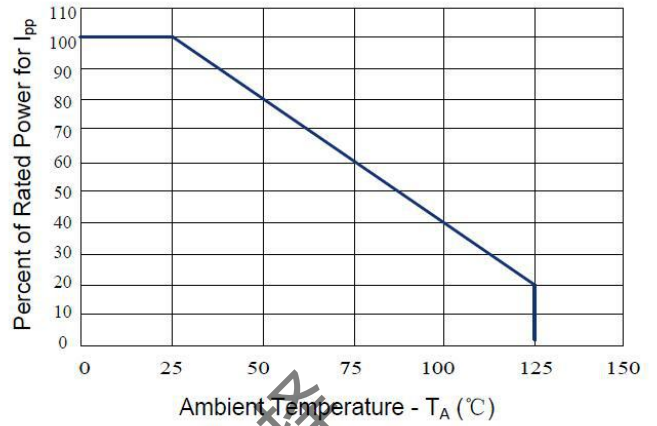


Figure 3: Clamping Voltage vs. Peak Pulse Current

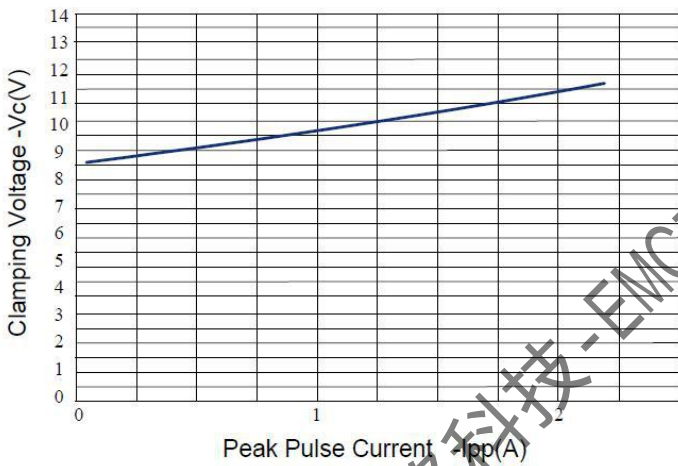


Figure 4: Normalized Junction Capacitance vs. Reverse Voltage

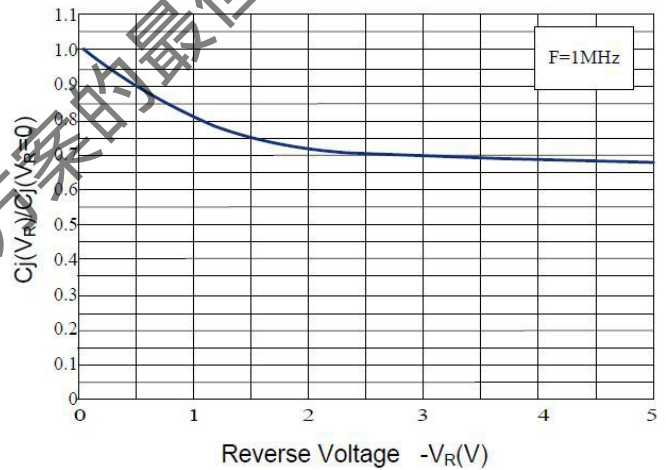
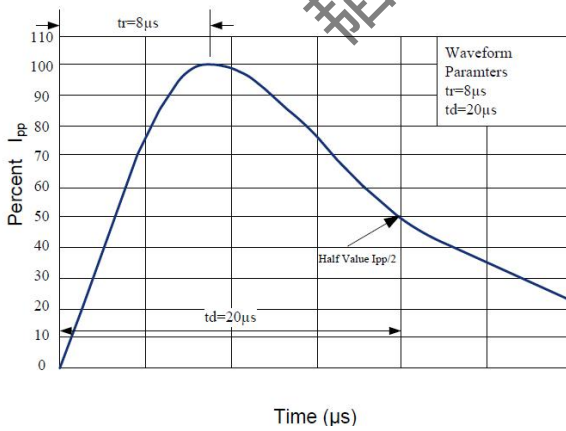
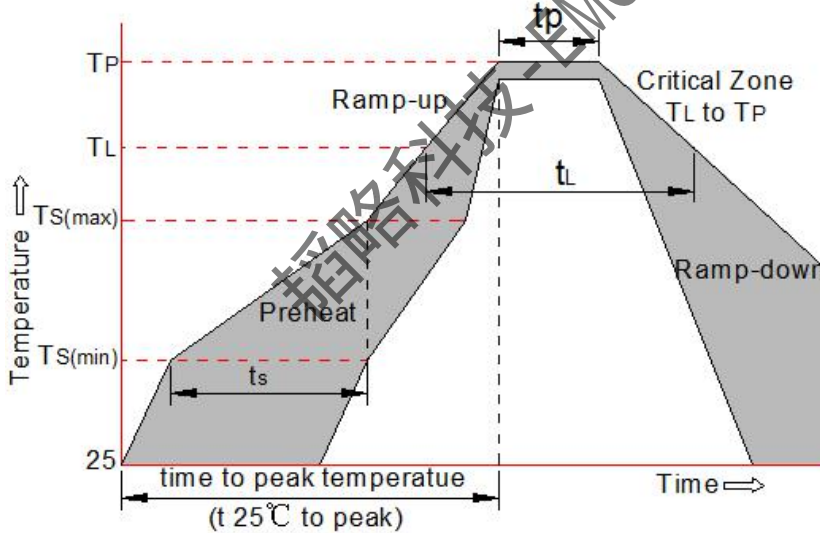


Figure 5: Pulse Waveform

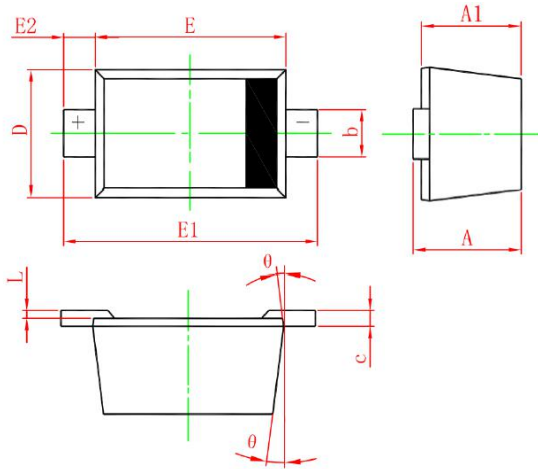


Soldering Parameters

Reflow Condition		Pb-Free Assembly (see as bellow)
Pre Heat	-Temperature Min ($T_{s(min)}$)	+150°C
	-Temperature Max($T_{s(max)}$)	+200°C
	-Time (Min to Max) (ts)	60-180 secs.
Average ramp up rate (Liquid us Temp (T_L) to peak)		3°C/sec. Max
$T_{s(max)}$ to T_L - Ramp-up Rate		3°C/sec. Max
Reflow	-Temperature(T_L) (Liquid us)	+217°C
	-Temperature(t_L)	60-150 secs.
Peak Temp (T_P)		+260(+0/-5)°C
Time within 5°C of actual Peak Temp (t_p)		30 secs. Max
Ramp-down Rate		6°C/sec. Max
Time 25°C to Peak Temp (T_P)		8 min. Max
Do not exceed		+260°C

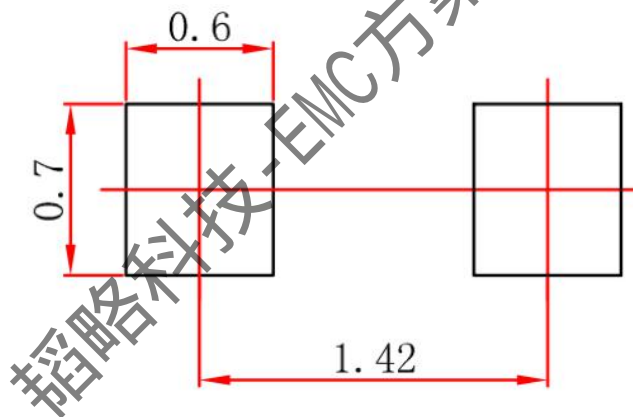


Package Mechanical Data



SYM	DIMENSIONS					
	MILLIMETERS			INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.51	-	0.77	0.020	-	0.031
A1	0.50	-	0.70	0.020	-	0.028
b	0.25	-	0.35	0.010	-	0.014
c	0.08	-	0.15	0.003	-	0.006
D	0.75	-	0.85	0.030	-	0.033
E	1.10	-	1.30	0.043	-	0.051
E1	1.50	-	1.70	0.059	-	0.067
E2	0.20REF			0.008REF		
L	0.01	-	0.07	0.001	-	0.003
Φ	7° REF			7° REF		

Suggested Land Pattern



Contact Information

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